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Alban Tay	/ Mahtani & De Silva		WRITTEN OPINION CONTROL OF THE CONTR			
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	binson Point			(PCT Rule 66)		
SINGAPORE 068911			Date of mailing (day/month/year)	2 5 445 2905		
Applicant's c	or agent's file reference	unnanna ag ann il delle e rousebbousee dissertia	REPLY DUE	within ONE MONTH		
TING/203	02314/KC/EK/kt			from the above date of mailing		
International	Application No.	International Filing Da		Priority Date (day/month/year)		
		19 September 2003		19 September 2003		
	al Patent Classification (IPC) or					
Int. Cl. 7	H01L 21/4763, 21/285, 23/	/36, 23/367, 23/373,	31/024, 31/052, 31/	18, H01S 5/024		
Applicant TIN	GGI TECHNOLOGIES PRI	VATE LIMITED et	t al	<u>~</u>		
) This wi	ritten opinion is the third dr	awn by this Internation	nal Preliminary Exam	ining Authority.		
	pinion contains indications relati					
I X	Basis of the opinion	ing to the following the	1110			
п	Priority					
	Non-establishment of opinion v	with research to morrellty im	ventive stan and industri	\$ J		
III [<u></u>	with regard to noverty, in	venuve step and muusut	ar applications		
IV [Lack of unity of invention					
v x			o novelty, inventive step	or industrial applicability; citations and		
vi 🗀	 explanations supporting such st Certain documents cited 	atement				
VII	Certain defects in the internatio	nal annlication				
<u> </u>	_					
VIII X	<u>-1</u>					
	NAL DATE by which the internation uary 2006	nal preliminary examina	tion report must be estab	olished according to Rule 69.2 is:		
4. The app	plicant is hereby invited to reply	y to this opinion.				
) When?	(i) a response being filed, or (ii) be established. The Report will the If no response is filed by 1 months basis of this opinion. Applicants wishing to have the beautiful and the basis.	one month before the Fir ake into account any resp of the Final Dat benefit of a further opinion	nal Date by which the in ponse (including amenda te, the international preli on (if needed) before the	will not establish the Report before the earling ternational preliminary examination report ments) filed before the Report is established minary examination report will be established report is established should ensure that a nai preliminary examination report must be		
How?	By submitting a written reply, ac			according to Rule 66.3.		
	For the form and the language of					
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I.	Basis of the	e opinion							
1.	1. With regard to the elements of the international application:*								
	the interna	the international application as originally filed.							
	X the descrip	ption, pages 1	-11, as orig	ginally filed,					
ļ		pages ,	filed with the	he demand,					
		pages ,	received on	with the letter of	-				
	X the claims	, pages 1	2-13, as orig	iginally filed,					
		pages ,	as amended	under Article 19,					
		pages ,	filed with the	ne demand,					
		pages 1	4-17, receiv	ved on 25 July 2005 with the let	tter of 25 July 2005				
	X the drawin	igs, pages 1	-5, as origina	nally filed,					
ļ		pages ,	filed with the	ne demand,					
		pages ,	received on	with the letter of		•			
()	the sequen	ice listing part of	the descriptio	on:					
		pages ,	as originally	y filed					
		pages ,	filed with th	he demand					
		pages ,	received on	with the letter of					
2.	2. With regard to the language, all the elements marked above were available or furnished to this Authority in the language in which the international application was filed, unless otherwise indicated under this item. These elements were available or furnished to this Authority in the following language which is:								
	the languag	ge of a translation	n furnished for	or the purposes of international se	earch (under Rule 23.1(b)).				
	the language	the language of publication of the international application (under Rule 48.3(b)).							
	the language of the translation furnished for the purposes of international preliminary examination (under Rules 55.2 and/or 55.3).								
3.		th regard to any nucleotide and/or amino acid sequence disclosed in the international application, the written opinion was wn on the basis of the sequence listing:							
	contained in the international application in printed form.								
	filed together with the international application in computer readable form.								
)	furnished subsequently to this Authority in written form.								
	furnished s	subsequently to th	is Authority i	in computer readable form.		٠			
		ent that the subse al application as t			es not go beyond the disclosure in the				
	The statement that the information recorded in computer readable form is identical to the written sequence li been furnished.				identical to the written sequence listing has				
4.	The amend								
	the	e description,	pages						
	the	e claims,	Nos.						
	the	e drawings,	sheets/fig.						
5.				ome of) the amendments had not cated in the Supplemental Box (F	t been made, since they have been considered to Rule 70.2(c)).	0			
	placement sheets wh ion as "originally fil		ished to the rec	ceiving Office in response to an invi	itation under Article 14 are referred to in this				

VIII. Certain observations on the international application

The following observations on the clarity of the claims, description, and drawings or on the question whether the claims are fully supported by the description, are made:

1. The claims are unclear with respect to the use of the term "wafer" (eg, independent claims 1, 43, 48 and 50), and the distinction between this term and "substrate". In common usage, a "wafer" typically refers to the common substrate on which a plurality of devices are formed. However, in Figure 1 the wafer 10 appears to refer to all elements of the devices, including the "substrate"; while in independent claims 1, 48 and 50 it appears that the wafer refers only to the device layers. For the purposes of this report I have interpreted "wafer" and "substrate" to be the same, and to refer to the layer on which the semiconductor devices of the claims are formed.

While the applicant has agreed with this interpretation, the claims remain *prima facie* unclear for the above reasons (in more detail, for example, claim 1 refers to a "substrate" on lines 1 and 7 but to a "wafer" on lines 2 and 4, *prima facie* suggesting these terms must refer to different features — this is further suggested by claim 15, which implies that the "wafer" remains after the removal of the "substrate" in step (c)).

As noted in the previous Opinion, this clarity issue is significant, as a different interpretation may lead to novelty and inventive step objections being raised (eg, Figures 2a and 2b of D1 in Box V show a copper layer electroplated on a 'wafer' device 1110, 1106, on the side remote from a 'substrate' 1105, with ohmic contacts 1020 and 1118, and with subsequent removal of the 'substrate' 1105).

2. Independent claim 1 is not clear with respect to "a <u>relatively</u> thick layer" (eg, line 5 of claim 1), and in particular whether 'relative' is in respect of the seed layer, the device layers, or the substrate. Perhaps it would be clearer if a functional criterion was given, such as sufficient thickness to provide a heat sink or mechanical support, or if a minimum thickness was given (eg, noting page 6 line 10, 50 microns).

The applicant has argued that the term "relatively" refers to the layer being relatively thick as opposed to relative to a particular feature. However, it is a matter of plain English that "relatively thick" has no absolute meaning; it intrinsically means thick in comparison to something else. Hence this argument must be rejected.